SAMG53G, SAMG53N

ARM-based Flash MCU

SUMMARY DATASHEET

Description

The Atmel[®] SAM G53 series is a member of the SAM G family of Flash microcontrollers based on the high-performance 32-bit ARM[®] Cortex[®]-M4 RISC processor. It operates at a maximum speed of 48 MHz and features up to 512 Kbytes of Flash and 96 Kbytes of SRAM. The peripheral set includes one USART, two UARTs, three I²C-bus interfaces (TWI), up to two SPIs, two three-channel general-purpose 16-bit timers, two I2S controllers with two-way, one-channel pulse density modulation, one real-time timer (RTT) and one 8-channel 12-bit ADC.

A general-purpose microcontroller with the best ratio in terms of reduced power consumption, processing power and peripheral set, the SAM G53 series sustains a wide range of applications including consumer, industrial control, and PC peripherals.

The device operates from 1.70V to 3.6V and is available in a 49-ball WLCSP package and a 100-pin LQFP package.

Features

- Core
 - ARM Cortex-M4 up to 48 MHz
 - Memory Protection Unit (MPU)
 - DSP Instructions
 - Floating Point Unit (FPU)
 - Thumb[®]-2 instruction set
- Memories
 - 512 Kbytes embedded Flash
 - 96 Kbytes embedded SRAM
- System
 - Embedded voltage regulator for single-supply operation
 - Power-on reset (POR) and Watchdog for safe operation
 - Quartz or ceramic resonator oscillators: 3 to 20 MHz with clock failure detection and 32.768 kHz for RTT or device clock
 - High-precision 8/16/24 MHz factory-trimmed internal RC oscillator. Inapplication trimming access for frequency adjustment

This is a summary document. The complete document is available on the Atmel website at www.atmel.com.

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- Slow clock internal RC oscillator as permanent low-power mode device clock
- PLL range from 24 MHz to 48 MHz for device clock
- 28 peripheral DMA (PDC) channels
- 8 x 32-bit General-Purpose Backup Registers (GPBR)
- 16 external interrupt lines
- Power consumption in active mode
 - 102 μA/MHz running Fibonacci in SRAM
- Low power modes (typical value)
 - Wait mode down to 8 µA
 - Wake-up time less than 5 µs
 - Asynchronous partial wake-up (SleepWalking[™])
- Peripherals
 - One USART with SPI mode
 - Two Inter-IC Sound Controllers (I2S)
 - Two-way one-channel Pulse Density Modulation (PDM) (interfaces up to two microphones in PDM mode)
 - Two two-wire UARTs
 - Three Two-wire Interface (TWI) modules featuring twoTWI masters and one high-speed TWI slave
 - One fast SPI at up to 24Mbit/s
 - Two three-channel 16-bit Timer/Counters (TC) with capture, waveform, compare and PWM modes
 - One 32-bit Real-Time Timer (RTT)
- I/O
 - Up to 38 I/O lines with external interrupt capability (edge or level sensitivity), debouncing, glitch filtering and on-die series resistor termination. Individually programmable open-drain, pull-up and pulldown resistor and synchronous output
 - Two up to 25-bit PIO Controllers
- Analog
 - One 8-channel ADC, resolution up to 12 bits, sampling rate up to 800 kSps
- Package
 - 49-ball WLCSP
 - 100-pin LQFP, 14 x 14 mm, pitch 0.5 mm
- Temperature operating range
 - Industrial (-40 °C to +85 °C)



1. Configuration Summary

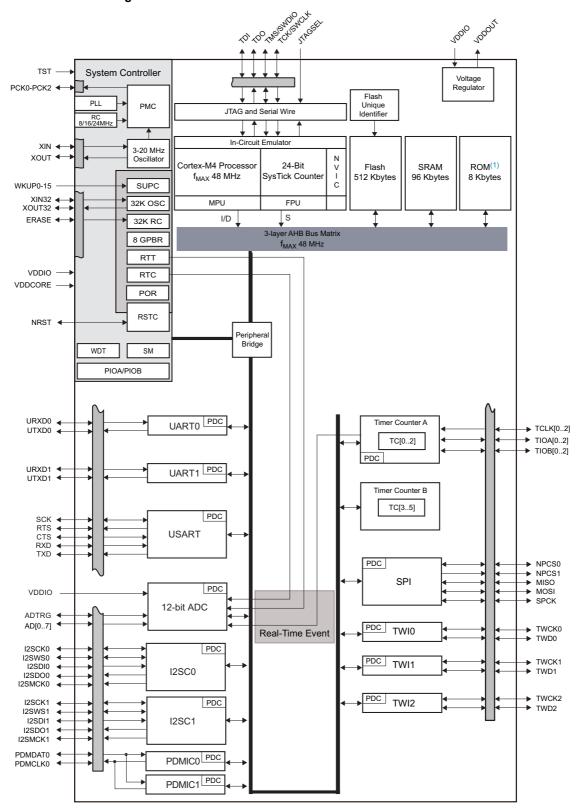
Table 1-1 summarizes the SAM G53 device configurations.

Feature	SAM G53G19	SAM G53N19
Flash	512 Kbytes	512 Kbytes
SRAM	96 Kbytes	96 Kbytes
Package	WLCSP49	LQFP100
Number of PIOs	38	38
Event System	Yes	Yes
	8 channels	8 channels
	Performance:	Performance
	800 KSps at 10-bit resolution	800 KSps at 10-bit resolution
	200 KSps at 11-bit resolution	200 KSps at 11-bit resolution
12-bit ADC	50 KSps at 12-bit resolution	50 KSps at 12-bit resolution
	6 channels	6 channels
16-bit Timer	(3 external channels)	(3 external channels)
I2SC/PDM	2 / 1-channel 2-way	2 / 1-channel 2-way
PDC Channels	28	28
USART/UART	1/2	1/2
SPI	1	1
	2 masters at 400Kbits/s and	2 masters 400Kbits/s and
TWI	1 slave at 3.4Mbit/s	1 slave 3.4Mbit/s

Table 1-1.Configuration Summary

2. Block Diagram





Note: 1. The ROM is reserved for future use.



3. Signal Description

Table 3-1 gives details on the signal names classified by peripheral.

Table 3-1.Signal Description List

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	Power Su	pplies			
VDDIO	Peripheral I/O Lines, Voltage Regulator, ADC Power Supply	Power	-	_	1.70V to 3.6V
VDDOUT	Voltage Regulator Output	Power	_	-	-
VDDCORE	Core Chip Power Supply	Power	-	_	Connected externally to VDDOUT
GND	Ground	Ground	_	_	-
	Clocks, Oscillato	ors and PLLs			
XIN	Main Oscillator Input	Input	_	VDDIO	Reset state:
XOUT	Main Oscillator Output	Output	_	_	- PIO input
XIN32	Slow Clock Oscillator Input	Input	-	VDDIO	- Internal pull-up disabled
XOUT32	Slow Clock Oscillator Output	Output	-	_	- Schmitt Trigger enabled
PCK0 - PCK2	Programmable Clock Output	Output	-	-	Reset state: - PIO input - Internal pull-up enabled - Schmitt Trigger enabled
	ICE and	JTAG	1		1
ТСК	Test Clock	Input	-	VDDIO	No pull-up resistor
TDI	Test Data In	Input	_	VDDIO	No pull-up resistor
TDO	Test Data Out	Output	_	VDDIO	-
TRACESWO	Trace Asynchronous Data Out	Output	_	VDDIO	-
SWDIO	Serial Wire Input/Output	I/O	_	VDDIO	_
SWCLK	Serial Wire Clock	Input	_	VDDIO	-
TMS	Test Mode Select	Input	_	VDDIO	No pull-up resistor
JTAGSEL	JTAG Selection	Input	High	VDDIO	Pull-down resistor
	Flash Me	emory			
ERASE	Flash and NVM Configuration Bits Erase Command	Input	High	VDDIO	Pull-down (15 kΩ) resistor

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
0		set/Test			
NRST	Microcontroller Reset	I/O	Low	VDDIO	Pull-up resistor
TST	Test Mode Select	Input	_	VDDIO	Pull-down resistor
	Universal Ansynchronous	Receiver Transce	eiver - UAR	Tx	1
URXDx	UART Receive Data	Input	_	_	-
UTXDx	UART Transmit Data	Output	_	_	_
	PIO Controll	er - PIOA - PIOB	1		
PA0 - PA24	Parallel I/O Controller A	I/O	_	VDDIO	Pulled-up input at reset. No pull-down for PA3/PA4/PA14.
PB0 - PB12	Parallel I/O Controller B	I/O	-	VDDIO	Pulled-up input at reset
	Wake	-up Pins			
WKUP 0-15	Wake-up Pin / External Interrupt	I/O	_	VDDIO	Wake-up pins are used also as External Interrupt
	Universal Synchronous Asynchi	onous Receiver	Transmitter	USART	
SCK	USART Serial Clock	I/O	-	-	-
TXD	USART Transmit Data	I/O	_	_	-
RXD	USART Receive Data	Input	-	-	-
RTS	USART Request To Send	Output	-	-	-
CTS	USART Clear To Send	Input	-	_	_
	Timer/Co	ounter - TCx			
TCLKx	TC Channel x External Clock Input	Input	_	_	_
TIOAx	TC Channel x I/O Line A	I/O	-	_	_
TIOBx	TC Channel x I/O Line B	I/O	_	_	_
	Serial Periphe	ral Interface - SP	1		
MISO	Master In Slave Out	I/O	_	_	-
MOSI	Master Out Slave In	I/O	_	_	-
SPCK	SPI Serial Clock	I/O	_	_	High-speed pad
NPCS0	SPI Peripheral Chip Select 0	I/O	Low	_	-
NPCS1	SPI Peripheral Chip Select 1	Output	Low	_	-

Table 3-1.Signal Description List



Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	Two-Wire In	terface- TWIx			
TWDx	TWIx Two-wire Serial Data	I/O	-	_	High-speed pad for TWD0
TWCKx	TWIx Two-wire Serial Clock	I/O	-	-	High-speed pad for TWDCK0
	10-bit Analog-to-Dig	ital Converter -	ADCC	<u>+</u>	•
AD0 - AD7	Analog Inputs	Analog	_	_	-
ADTRG	ADC Trigger	Input	_	_	_
	Inter-IC Sound	Controller - I2SC	x		
I2SMCKx	Master Clock	Output	_	_	_
I2SCKx	Serial Clock	I/O	_	_	_
I2SWSx	I2S Word Select	I/O	_	_	_
I2SDIx	Serial Data Input	Input	-	-	_
I2SDOx	Serial Data Output	Output	_	_	_
PDMCLK0	Pulse Density Modulation Clock	Output	_	_	_
PDMDAT0	Pulse Density Modulation Data	Input	_	_	-

Table 3-1.Signal Description List

4. Package and Pinout

Table 4-1.	SAM G53	Packages
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Device	Package
SAM G53G19	WLCSP49
SAM G53N19	LQFP100

4.1 49-ball WLCSP Pinout

 Table 4-2.
 SAM G53G19 49-ball WLCSP Pinout

PA9	
GND	
PA24	
PB8/XOUT	
PB9/XIN	
PB4	
VDDIO	
PB11	
PB5	
PB7	
PA2	
JTAGSEL	
NRST	
PB12	
	GND PA24 PB8/XOUT PB9/XIN PB4 VDDIO PB11 PB5 PB7 PB7 PA2 JTAGSEL NRST

9-ball WLCSP Pinout		
C1	VDDCORE	
C2	PA11	
C3	PA12	
C4	PB6	
C5	PA4	
C6	PA3	
C7	PA0	
D1	PA13	
D2	PB3/AD7	
D3	PB1/AD5	
D4	PB10	
D5	PA1	
D6	PA5	
D7	VDDCORE	

E1	PB2/AD6
E2	PB0/AD4
E3	PA18/AD1
E4	PA14
E5	PA10
E6	TST
E7	PA7/XIN32
F1	PA20/AD3
F2	PA19/AD2
F3	PA17/AD0
F4	PA21
F5	PA23
F6	PA16
F7	PA8/XOUT32
	•

G1	VDDIO
G2	VDDOUT
G3	GND
G4	VDDIO
G5	PA22
G6	PA15
G7	PA6



4.2 100-lead LQFP Pinout

Table 4-3. SAM G53N19 100-pin LQFP Pinout

1	NC
2	NC
3	NC
4	NC
5	VDDIO
6	VDDIO
7	NRST
8	PB12
9	PA4
10	PA3
11	PA0
12	PA1
13	PA5
14	VDDIO
15	VDDCORE
16	VDDCORE
17	TEST
18	PA7
19	PA8
20	GND
21	NC
22	NC
23	NC
24	NC
25	NC

	i F Fillout
26	NC
27	NC
28	PA6
29	VDDIO
30	PA16
31	PA15
32	PA23
33	NC
34	NC
35	PA22
36	PA21
37	VDDIO
38	VDDIO
39	GND
40	GND
41	GND
42	GND
43	GND
44	VDDOUT
45	VDDOUT
46	VDDIO
47	VDDIO
48	VDDIO
49	NC
50	NC

51	NC
52	NC
53	PA17
54	PA18
55	PA19
56	PA20
57	PB0
58	PB1
59	PB2
60	PB3
61	VDDIO
62	PA14
63	PA13
64	PA12
65	PA11
66	VDDCORE
67	VDDCORE
68	PB10
69	PB11
70	GND
71	GND
72	PA10
73	NC
74	NC
75	NC

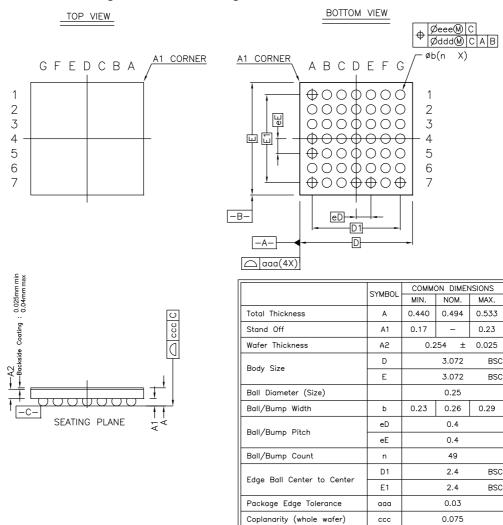
76	NC
77	NC
78	NC
79	PA9
80	PB5
81	GND
82	GND
83	GND
84	PB6
85	PB7
86	PA24
87	PB8
88	PB9
89	VDDIO
90	PA2
91	PB4
92	NC
93	JTAGSEL
94	VDDIO
95	VDDIO
96	NC
97	NC
98	NC
99	NC
100	NC



5. Mechanical Characteristics

5.1 49-lead WLCSP Package

Figure 5-1. 49-lead WLCSP Package Mechanical Drawing



Ball/Bump Offset (Package)

Ball/Bump Offset (Ball)

ddd

eee

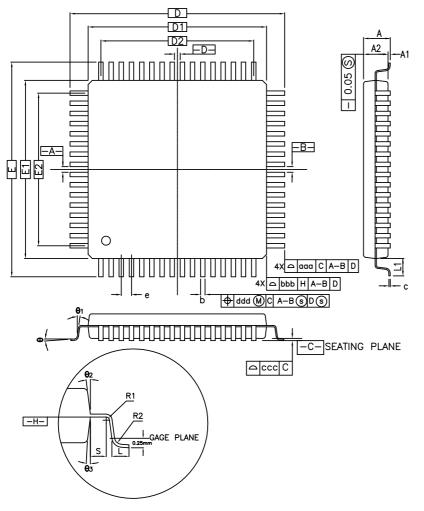
0.05

0.015



5.2 100-lead LQFP Package





COTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	М	ILLIMET	ER	INCH		
STMBUL	MIN. NOM.		MAX.	MIN.	NOM.	MAX.
A	—	_	1.60	—	_	0.063
A1	0.05		0.15	0.002		0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D	10	6.00 B	SC.	0.630 BSC.		
D1	1.	4.00 B	SC.	0.551 BSC.		
E	10	5.00 B	SC.	0.630 BSC.		
E1	14	4.00 B	SC.	0.551 BSC.		
R2	0.08 —		0.20	0.003		0.008
R1	0.08	—	—	0.003	_	—
θ	0*	3.5*	7*	0.	3.5*	7*
θ1	0*			0.		
θε	11*	12	13 '	11.	12	13 °
θ₃	11•	12 '	13 '	11.	12 '	13 °
с	0.09		0.20	0.004		0.008
L	0.45	0.60	0.75	0.018	0.024	0.030
L ₁	1.00 REF			0.039 REF		
S	0.20	_	_	0.008		—

	100L						
SYMBOL	MILLIMETER				INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
b	0.17	0.20	0.27	0.007	0.008	0.011	
е	(D.50 E	SC.	0.020 BSC.			
D2	12.00		0.472				
E2	12.00		0.472				
aaa	0.20			(3.008		
bbb	0.20		bbb 0.20			800.0	
CCC	0.08		C 0.08 0.003				
ddd	0.08			0.003			

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6. Ordering Information

Ordering Code	MRL	Flash (Kbytes)	Package	Carrier Type	Package Type	Temperature Operating Range
ATSAMG53G19A-UUT	A	512	WLCSP49	Tape and Reel	Green	Industrial -40°C to 85°C
ATSAMG53N19A-AU	Α	512	LQFP100	Tray	Green	Industrial -40°C to 85°C
ATSAMG53N19A-AUT	A	512	LQFP100	Tape and Reel	Green	Industrial -40°C to 85°C

 Table 6-1.
 Ordering Codes for SAM G53 Devices



7. Revision History

In the tables that follow, the most recent version of the document appears first.

Doc. Rev. 11240CS	Changes
	Updated document title on first page
	Minor formatting changes throughout
04-Jun-14	Section 6. "Ordering Information"
	Table 6-1, "Ordering Codes for SAM G53 Devices": added prefix 'AT' to ordering codes; deleted "(Kbytes)" from "Package" column header; added "Carrier Type" column

Table 7-1. SAM G53 Datasheet Rev. 11240CS Revision History

Table 7-2. SAM G53 Datasheet Rev. 11240BS Revision History

Doc. Rev. 11240Bs	Changes
	Operating voltage range changed to 1.70V to 3.6V throughout.
	Figure 2-1 "SAM G53 Block Diagram": added VDDIO on ADC.
06-May-14	Table 4-3, "SAM G53N19 100-pin LQFP Pinout": corrected pin 92 to NC.
	Figure 5-1 "49-lead WLCSP Package Mechanical Drawing": changed values for backside coating and for min of
	Total Thickness.

Table 7-3. SAM G53 Datasheet Rev. 11240As Revision History

Doc. Rev. 11240AS	Changes
14-Jan-14	First issue

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